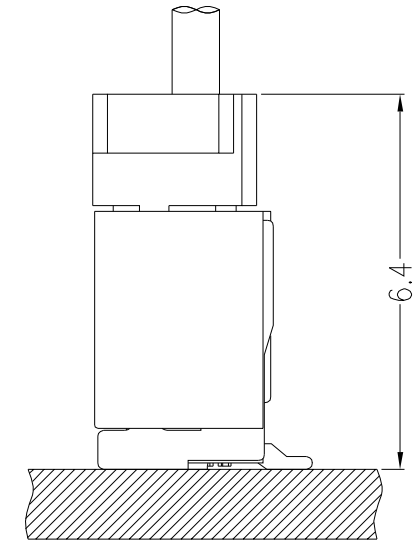
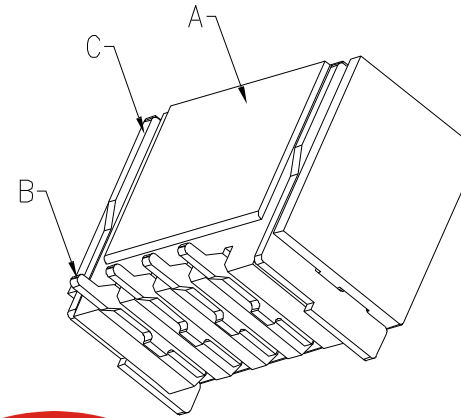
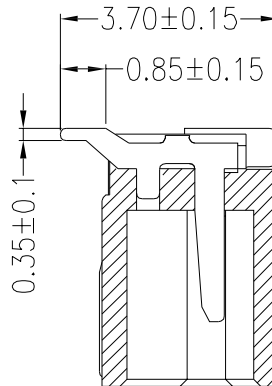
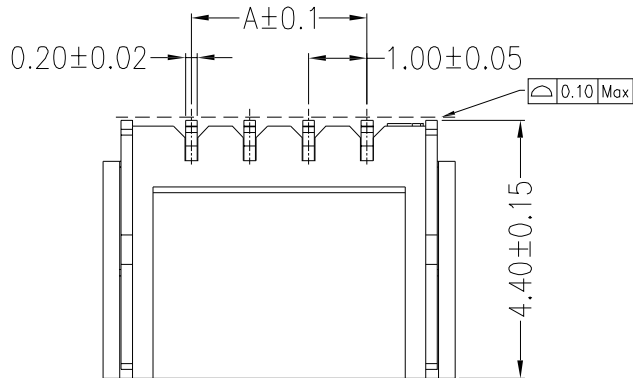
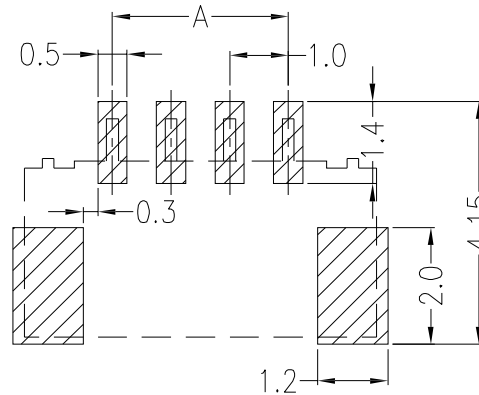
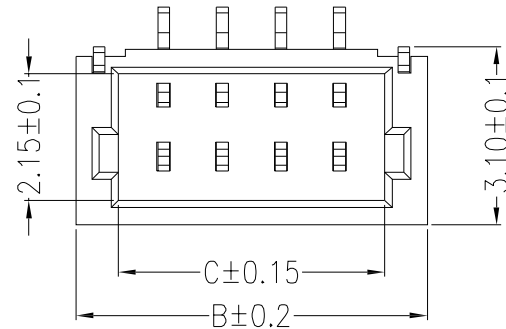




Assembly Layout



Recommend PCB Layout

主要技术参数 Main Specifications

线 数 (Poles): 02 to 20

接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$

绝缘电阻 (Insulation resistance): $\geq 100\text{M}\Omega$

额定电压 (Rated voltage): 50V AC DC

额定电流 (Rated current): 0.5A AC DC

耐 电 压 (Withstand Voltage): 500V AC/minute

温度范围 (Temperature Range): $-25^{\circ}\text{C} \sim +105^{\circ}\text{C}$

Circuit	Dimensions (mm)			Circuit	Dimensions (mm)		
	A	B	C		A	B	C
02	1.00	4.00	2.50	10	9.00	12.00	10.50
03	2.00	5.00	3.50	11	10.00	13.00	11.50
04	3.00	6.00	4.50	12	11.00	14.00	12.50
05	4.00	7.00	5.50	13	12.00	15.00	13.50
06	5.00	8.00	6.50	14	13.00	16.00	14.50
07	6.00	9.00	7.50	15	14.00	17.00	15.50
08	7.00	10.00	8.50	16	15.00	18.00	16.50
09	8.00	11.00	9.50	20	19.00	22.00	20.50

NO.	DESCRIPTION	QTY	MATERIAL	PLATING/COLOR
A	Insulator	1	LCP (UL94V-0)	Beige
B	Contacts	2~20	PhosphorBronze	Tin-plated
C	SolderTab	2	PhosphorBronze	Tin-plated



UNITS mm		东莞市朗纶电子制品有限公司 Dongguan langlun electronic products Co., Ltd			
MAT'L		PART NO.(INTENDED USE) 1. 0-P-nPB		TITLE: SH1. 0立贴针座	
FINISH		APPD:		DWG NO.: 1. 0-P-nPB	
Q'TY PCS		CHKD:		SCALE 1/1	
DR: HU 2016.09.28		SHEET 1/1		REV. A	